

Customer:

深圳市田治实业有限公司

Shenzhen Tenji Industrial Co., Ltd.

Add:宝安区西乡镇桃花源科技创新园第三分园1区2楼

SPECIFICATION FOR LCD MODULE

Product Model:		TJ320035A-00	
Sample co	ode:		
Designed by		Checked by	Approved by
蔣尚		李世佼	
nal Appro	oval by C	Sustomer	
nal Appro		Sustomer LCM	OK
7	ninery OK	LCM	
LCM Mach	ninery OK	LCM	OK Problem survey:

*The specification of "TBD" should refer to the measured value of sample. If there is difference between the design specification and measured value, we naturally shall negotiate and agree to solution with customer.

Revision History

Version	Contents	Date	Note
Α	Original	2012-08-23	

Contents

No.	Item	Page
2	Scope	4/20
3	Normative Reference	4/20
4	Definitions	4/20
5	Technology Specifications	6/20
6	Circuit block diagram	9/20
7	Reliability Test Condition and Methods	10/20
8	Inspection standard	11/20
9	Handling Precautions	17/20
10	Precaution for use	19/20
11	Dimensional Outline	20/20

2 Scope

This specification applies to the TFT LCD module which is designed and manufactured by LCM Factory of Tianji industral Co.,Ltd.

It is capable of using 262K colors mode, 8bit MCU interface

3 Normative Reference

GB/T4619-1996 《 Liquid Crystal Display Test Method》

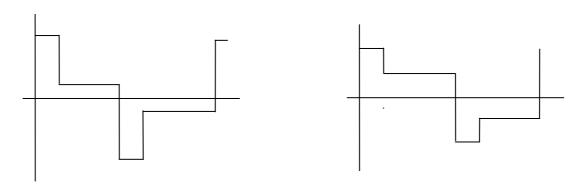
GB/T2424 《Basic environmental Testing Procedures for Electric and Electronic Products.》

GB/T2423 《Basic Testing Procedures for Electric and Electronic Products》 IEC61747-1 《SIXTH PARTGB2828`2829-87《National Standard of PRC》

4 Definitions

4.1 Definitions of Vop

The definitions of threshold voltage Vth1, Vth2 the following typical waveforms are applied on liquid crystal by the method of equalized voltage for each duty and bias.



[selected waveform]

I non-selected waveform]

- \odot Vth1: The voltage which the brightness of segment indicates 50% of saturated value on the conditions of selected waveform (f_f=80Hz, Φ =10° θ =270°at 25°C)
- ② Vth2: The voltage which the brightness of segment indicates 50% of saturated value on the conditions of non-selected waveform $(f_f=80\text{Hz}, \Phi=10^\circ\theta=270^\circ\text{at}\ 25^\circ\text{C})$
 - ③ Vop: (Vth1(50%)+Vth2(50%))/2 $(f_f=80Hz, \Phi=10^\circ\theta=270^\circ at 25^\circ C)$

4.2 Definition of Response Time Tr, Td

- ①Tr: The time required which the brightness of segment becomes 10% from 100% when waveform is switched to selected one from non-selected one. (f_f =80Hz, Φ =10° θ =270°at 25°C)
- ②Td: The time required which the brightness of segment becomes 90% from 10% when waveform is switched to selected one from selected one. (f_f =80Hz, Φ=10°θ=270°at

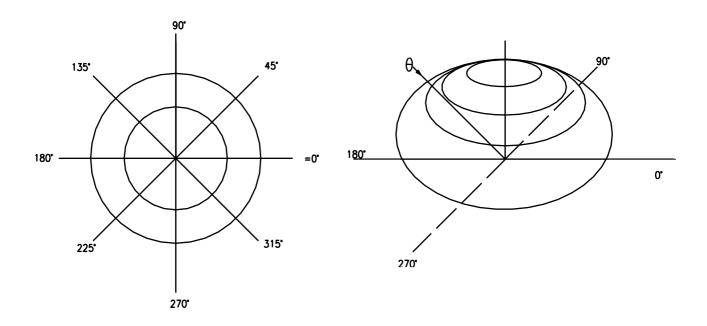
25°C)

4.3 Definition of Contrast Ratio Cr

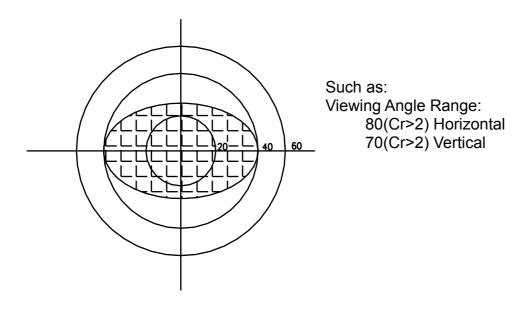
Cr=A/B

- 1 A: Segments brightness in case of non-selected waveform
- 2 B: Segments brightness in case of selected waveform

4.4 Definition of Angle and Viewing Range



Angular Graph: Constrast Ratio



5 Technology Specifications

5.1 Feature

Display operating Mode: Normally White

Display Color : 262K color

Display Format : 240×400 Pixels

Input data : 8-bit MPU I/F

Viewing Direction : 6 o'clock

LCD Driver : HX8352C

5.2 Mechanical Specifications

Item	Specifications	Unit
Dimensional outline	47.66(W) ×80.90(H)×2.3(T)	mm
Active area	41.76 (W) ×69.6 (H)	mm
Pixel size	0.174(W) ×0.174(H)	mm
Dot pitch	0.058(W) ×0.174(H)	mm

5.3 Absolute Max. Rating

Itom	Symbol		Value	Unit	Remark	
Item		Min	typ	Max	Offic	Remark
Supply voltage	VCI	2.4		3.3	V	
Input voltage	V _{IN}	-0.3		VCI+0.3	V	
Operating temperature	T _{OPR}	-20		+70	°C	
Storage temperature	T _{STG}	-30		+80	°C	

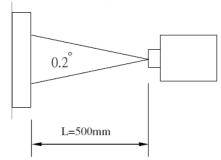
5.4 Electrical Characteristics (VSS=0V,Ta=-20 to 70°C)

Item	Symbol	Condition	Min	Тур	Max	Unit
Input high voltage	V_{IH}	V _{DD} =1.8~3.3V	$0.8 V_{DD}$	ı	V_{DD}	V
Input low voltage	V_{IN}	V _{DD} =1.8~3.3V	-0.3	ı	$0.2 V_{DD}$	V
Output high voltage	V_{OH}	I_{OH} =-0.1mA	$0.8~V_{DD}$	ı	-	V
Output low voltage	V _{OL}	V_{DD} =1.65~3.3V I_{OL} =0.1mA	ı	ı	0.2 V _{DD}	V
Current consumption for LCD	I _{DD1}	1	-0.1	-	0.1	uA

5.5 Optical specifications

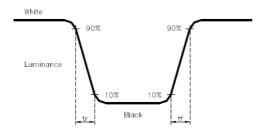
ITEN	1	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
Luminance		L		180	200	-	cd/m ²	
Contrast	Ratio	CR		150	200	-		Note 3
Response	Timo	Tr	$\theta = \Psi = 0^{\circ}$		12	16	ms	Note 4
Response	Tille	Tf	θ = ψ - 0	-	18	24	ms	
	Upper	θ		55	60	•	٥	
View angle	Lower	Ө	CR≧5	-15	-20		0	Note 5
view aligie	Left	à	OH≦3	-40	-45		0	14016-2
	Right	ф		40	45		0	
		Х		0.588	0.608	0.628		
	R	у		0.306	0.316	0.326		
		Υ		17.8	20.8	23.8		
		Х		0.295	0.305	0.315		
	G	у		0.536	0.556	0.576		
Color Filter		Υ	$\theta = \Psi = 0^{\circ}$	57.6	61.6	65.6		Note 6
Chromacicity		Х	$\theta = \psi - 0$	0.125	0.135	0.145		Note 6
	В	у		0.122	0.137	0.152		
		Υ		13.2	16.2	19.2		
		Х		0.285	0.305	0.325		
	W	у		0.314	0.334	0.354		
		Υ		28.9	32.9	36.9		

Note 1. Ambient condition: $25^{\circ}C \pm 2^{\circ}C$, $60\pm 10\%$ RH, under 10 Lunx in the darkroom. Note 2. Measure device: BM-5A (TOPCON), viewing cone=0.2°, I_L=15mA, after 10 minutes operation.

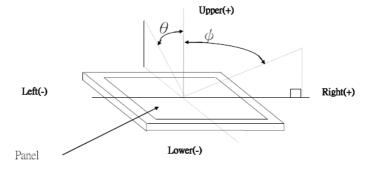


Note 3. Definition of Contrast Ratio: CR = White Luminance (ON) / Black Luminance (OFF)

Note 4. Definition of response time: The response time is defined as the time interval between the 10% and 90% amplitudes.



Note 5. Definition of view angle(θ , ψ):



5.6 LED back light specification (6 White Chips)

7/20 REV.A %All Rights Reserved

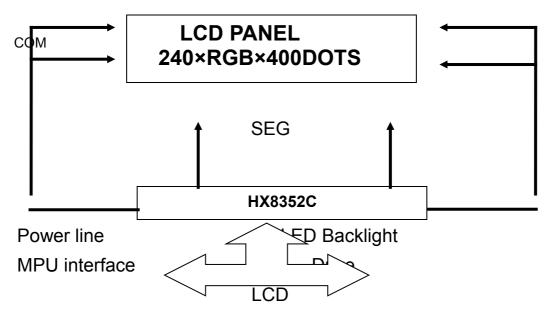
Item	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	Vf	lf=90mA		3.2		V
Uniformity (with L/G)	ΔB _p	lf=90mA	90	-	-	%
Luminance for LCD	L_V	If=90mA		-	-	cd/m ²

5.7 Interface Pin Connections

PIN NO.	Symbol	Description
1	LEDK2	LED backlight(Cathode)
2	LEDK1	LED backlight(Cathode)
3	LEDA	LED backlight(anode)
4	GND	Ground
5	DB8	DATA BUS
6	VCC(2.8V)	supply voltage
7	WR	Write execution control pin
8	RS	Command/Display data select pin
9	RESET	Reset pin.
10	CS	Chip select
11	RD	Read execution control pin
12	FMARK	Tearing Effect
13	VCC(2.8V)	supply voltage
14	DB15	DATA BUS
15	DB14	DATA BUS
16	DB13	DATA BUS
17	DB12	DATA BUS
18	DB11	DATA BUS
19	DB10	DATA BUS
20	DB9	DATA BUS
21	LEDK3	LED backlight(Cathode)
22	LEDK4	LED backlight(Cathode)
23	LEDK5	LED backlight(Cathode)
24	LEDK6	LED backlight(Cathode)

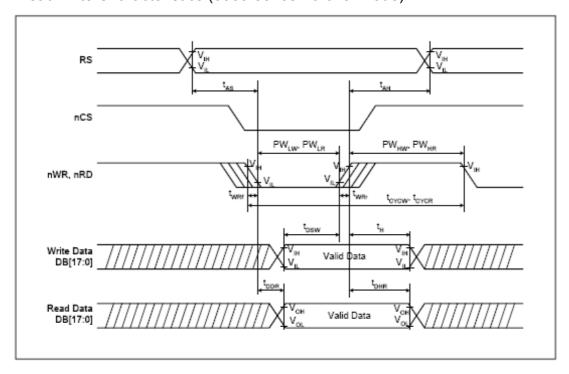
6 Signal timing diagram and Circuit block diagram

6.1 Circuit block diagram



6.2 Signal Timing Diagram For Main LCD Driver HX8352C.

Read/write Characteristics (8080-series Parallel mode)



Reset Operation



7 Reliability Test Conditions And Methods

NO	Item	Condition	Method
1	High / Low Temperature Storage	80°C/-30°C 120hrs	Check and record every 48Hrs
2	High / Low Temperature Life	70℃/-20℃ 120hrs (operating mode)	Check and record every 48Hrs
3	High Temperature、 High Humidity Operating	60°C,90% RH, 96Hrs	Check and record every 48hrs
4	Thermal Shock	-30°C(30Min)	Each 10 cycles end , check
5	Vibration	10Hz~55Hz~10Hz Amplitude: 1.5mm 2hrs for each direction(X,Y,Z)	Each direction end, Check the Appearance and Electrical Characteristics
6	Static Electricity	Gap mood: ±1KV~±8KV (10 times air discharge with positive/negative voltage voltage gap : 1kv) Touch mood: ±1KV~±4KV	Each discharge end, Check the Electrical Characteristics
7	Curve	60 Thousand times, 40 times/min 150°(according to die if exist)	Check and record every 2~4 thousand times
8	Slump	Free faller movement for each side cording angle (75cm High 6 sides 2 angle 2 cording)	End

8 Inspection standard

Item		Criterion				
Outline Dimension	In a	In accord with drawing				
Position- finding Dimension Assemble Dimension	In accord with drawing					
	Round type: non display					
	• y •	Dimension	Qualified Quantity			
\longrightarrow	_ × ↑	D≤0.1	Ignore			
		0.1 <d≤0.15< td=""><td>2</td></d≤0.15<>	2			
		D>0.15	0			
LCD black spots, white spots (Round	3.2Large area LCD		Qualified			
type)	→	Dimension	Quantity			
	$\rightarrow \uparrow \uparrow x \leftarrow \downarrow \downarrow$	D≤0.1	Ignore			
		0.1 <d≤0.15< td=""><td>2</td></d≤0.15<>	2			
		0.15 <d≤0.20< td=""><td>1</td></d≤0.20<>	1			
		D>0.20	0			
	C-STN : if D>0.1 , unc	jualified				
	Outline Dimension Position- finding Dimension Assemble Dimension LCD black spots, white spots (Round	Outline Dimension Position-finding Dimension Assemble Dimension Round type: non displation and spots and spots, white spots (Round type) 3.2 Large area LCD y x 3.2 Large area LCD	Outline Dimension Position-finding Dimension Assemble Dimension Round type: non display 3.1 Small area LCD Unit: mm Dimension D≤0.1 0.1 <d≤0.15 d="">0.15 LCD black spots, white spots (Round type) 3.2Large area LCD Dimension D≤0.1 0.1<d≤0.15 d="">0.15 D≤0.1 0.1<d≤0.20< td=""></d≤0.20<></d≤0.15></d≤0.15>			

		4.1 \$	Small area L	CD U	nit : mm		
		↓ w	Length	Width	Qualified Quantity		
		<u> </u>	-	≤0.015	Ignore		
		 └──	≤1.0	0.015<	2		
			≤2.0	W≤0.025	1		
			≤1.0	0.025< W≤0.05	1		
			-	D>0.05	According to circle		
			4.2Larg	je area LCD			
	LCD black spots,		Length	Width	Qualified Quantity		
04	white spots		-	≤0.015	Ignore		
	(Line Style)		≤2.0	0.015 <i><</i> W≤0.025	2		
			≤1.0	0.025 <i><</i> W≤0.05	1		
			-	D>0.05	According to circle		
			L L				
					015 , unqualified nd viewing area		
05	LCD Scratch 、 Threadlike Fiber	Same to NO.3 circle sightline and surface of LCD is vertical (2)Same to NO.3 line style					
06	POL	It is not admissible that POL is beyond the edge of glass, else, unqualified. It is essential that POL is over the 50 percent of width of frame, else, unqualified. According to the drawing in case of special definition.					

	IC/FPC Bonding	Scratch	Reject	
07		Intensity Of Adhesion	If lower than specification, reject	
		Gold Fold Twist	Reject	
07	IC/FPC Bonding	Silicon	According to outline, no gold outside, seal can not be higher than LCD	
07		FPC Gold Sever	Reject	
08	SMT	Lack of Component、Polar ity Inverse	If exist, reject	
		Leak Solder、 Virtual Solder	If exist, reject	
		Short Circuit In Solder Point	If exist, reject	
		Tin Ball	If exist, reject	
		Tin Acumination	If visual, reject	
		Height Solder Point	If higher 0.5mm than component. reject	
		Height of component	Either side higher 0.5mm than component, reject	

		Component Shift	X Solder Pad component D X<3/4Z reject y>1/3D reject
08	SMT		
		Few Tin	PCB pad PCB If θ≤20° reject
		Component Deflection	Component D Pad If Y >1/3D reject
		Component Carcass Sideways	Reject

		Component Carcass Sideways	If exist with visual inspection , reject	
		A: Tin accrete the solder side completely, hollowly,Ok B: Tin accrete the solder side completely, full circle arc, ok C: Jointing include whole solder side, height of tin>50 percent of height of component, reject		
		Few Tin	A: Tin accrete the solder side completely, hollowly,Ok B: height of tin > 1/3 of solder side of component, ok C: height of tin ≤ 1/3 of solder side of component, reject	
08	SMT	Normal Jointing side		
	Light	Short circuit 、 Open circuit	Forbid	
09		Quality of CSTN Display	1. Rolling strake with visual inspection, forbid 2. Differentness of color in viewing area with visual inspection (full white. red . green. blue), forbid 3. Display change with visual inspection, forbid	

			Х	у		
10		white	±0.05	±0.05		
		Red	±0.05	±0.05		
		Green	±0.05	±0.05	Drive LCD under normal	
	Color Of CIE	Blue	±0.05	±0.05	condition, 25°C Φ=0 θ=0	
	Coordinate	According to the sp			Test white red green blue	
		or sample custor approved		mer have	with DMS Record	
					ndition is according to	
				specification Measure location is in Follow Picture 3. Adjust brightness instrument tozero, burrow against the surface of LCD,		
				press "me display is s	easure", record when the	
		In accord with product		OGAWA-3298)		
11	Brightness					
		specification				
				Measure location		
12	CD (May)	According to specification		Accordii	ng to product specification	
12	CR (Max)			Measure instrument (DMS-501)		
	Response	According to specification		According to product specification		
13	time			Measure instrument (DMS-501)		
	\ /: - '					
14	Viewing angle	According to specification			ng to product specification re instrument (DMS-501)	
	33.0			modelie mediament (Divid out)		
15	Vibration \ Ring	Compare with the sample customer supply		Compare with the sample customer supply when assemble		
15						
		According to the use of product (main FPC of foldaway cell phone ≥6 thousand)		Manager in the state of		
16	Frequency				Aleasure instrument Bend angle : 150°	
	Of FPC				C in the casement when	
	Bend			customer supply		

9 Handling Precautions

9.1 Mounting method

The LCD panel of Daxian LCD module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

9.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent [recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns

Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (CI), Salfur (S)

If goods were sent without being sili8con coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Salfur (S) from customer, Responsibility is on customer.

9.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to Vdd or Vss, do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

9.4 packing

- Module employ LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

9.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or

\$\$\text{\$\sigma}\$All Rights Reserved 17/20 REV.A

out of order with LCD's, which will come back in the specified operation temperature.

- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

Usage under the maximum operating temperature, 50%Rh or less is required.

9.6 storage

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else.
 [It is recommended to store them as they have been contained in the inner container at the time of delivery from us

9.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water

10 Precaution for use

10.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

10.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification
- When a new problem is arisen which is not specified in this specifications
- When an inspection specifications change or operating condition change in customer is reported to Daxian , and some problem is arisen in this specification due to the change
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

11 Dimensional Outline

ØAll Rights Reserved 18/20 REV.A

